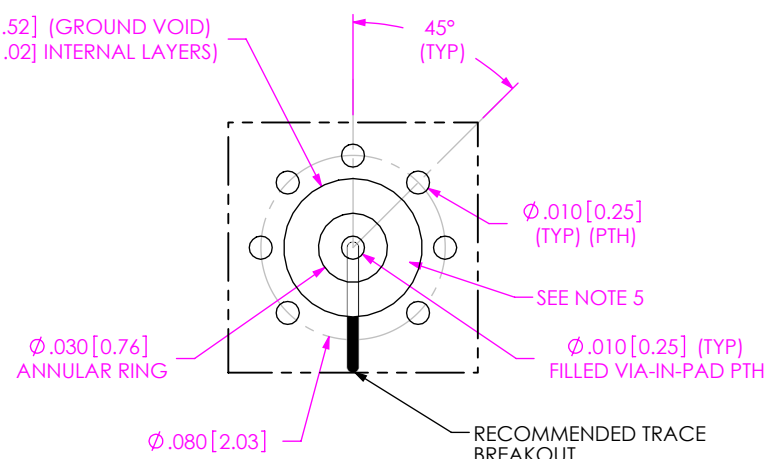


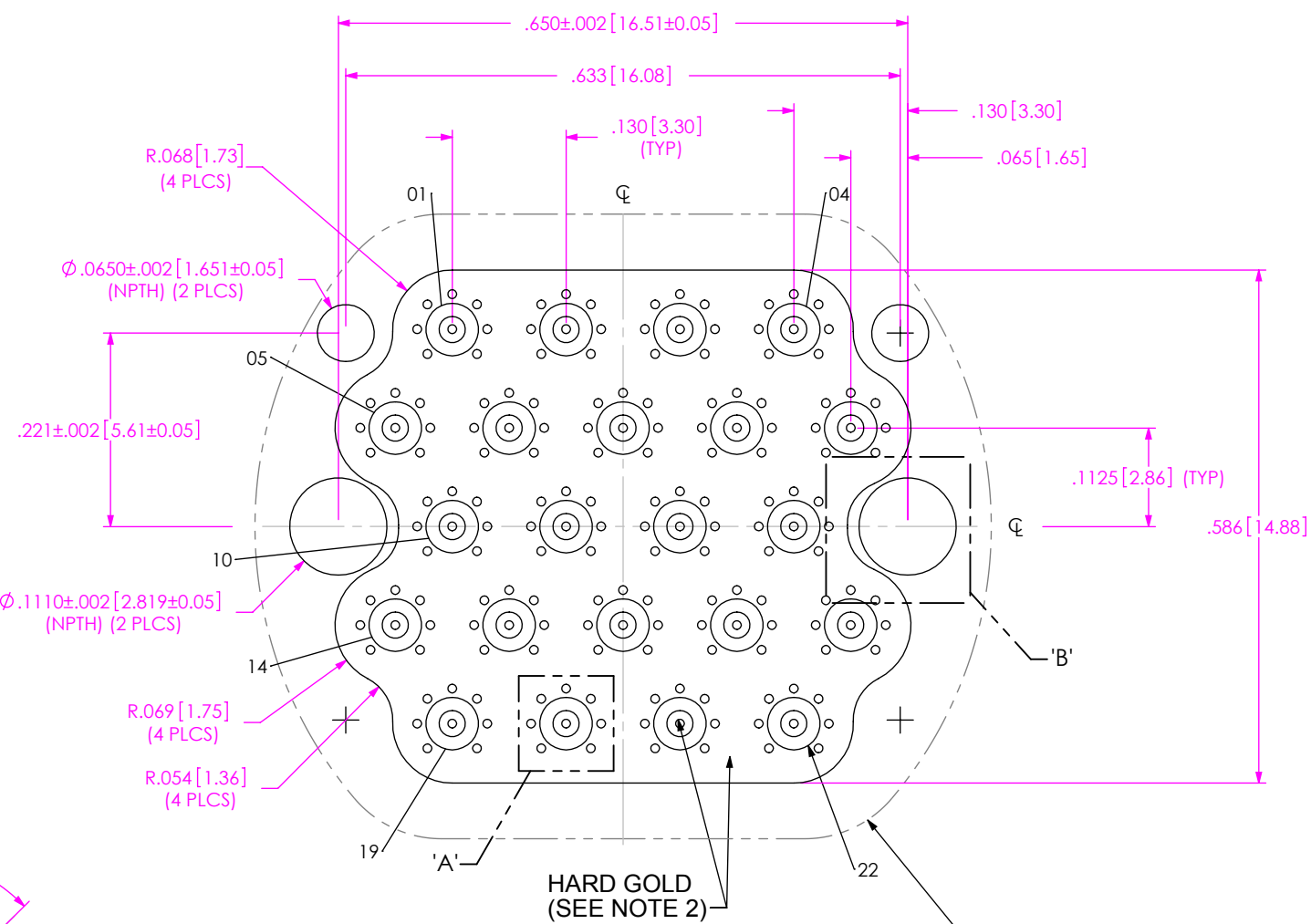
DETAIL 'B'
SCALE 10:1

Ø.060 [1.52] (GROUND VOID)
(Ø.040 [1.02] INTERNAL LAYERS)



DETAIL 'A'
SCALE 12:1
(TYPICAL ON ALL POSITIONS)

RECOMMENDED TRACE
BREAKOUT
(SEE NOTE 6)



CONNECTOR SIDE VIEW

HARD GOLD
(SEE NOTE 2)

KEEP OUT AREA

- NOTES:
1. ALL DIMENSIONS ARE SYMMETRIC ABOUT THE CENTERLINE.
 2. PLATING TO BE .000030 INCHES GOLD WITH A HARDNESS OF 130-200 KNOOP PER ASTM B 488 TYPE 2, GRADE C.
 3. - DELETED -
 4. BACKDRILL SIGNAL VIAS FOR OPTIMUM PERFORMANCE.
 5. AREA DOES NOT REQUIRE SOLDER MASK.
 6. TRACE CAN BE ROUTED IN ANY DIRECTION.



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